

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-128128FC-6A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS			
Product Mgr	r Doc. Control Electr. Eng		
Bazile Peter	Anthony Perkins	Rekha Mani	
Date: 17/03/10	Date: 17/03/10	Date: 17/03/10	



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	05 August 09			First Issue	
В	04 Nov 09	10	3.3	PIN 17 and 18 corrected	
С	17 Mar 10	8 9	3.2 3.3 3.3	Note1 and 2 : VCC=13V R/W# : When serial mode is selected, this pin must be connected to VSS 17: BS0 18: BS1	

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1 MAIN FEATURES

ITEM	CONTENTS
Display Format	128 (RGB) x 128 Dots
Overall Dimensions	33.8 x 34.00 x 1.60 mm
Colour	262,144 Colour
Active Area	26.855 x 26.864 mm
Viewing Area	28.855 x 28.864 mm
Display Mode	Passive Matrix (1.50")
Driving Method	1/128 duty
Driver IC	SSD1351
Operating temperature	-30 ∼ +70
Storage temperature	-40 ∼ +80

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2 MECHANICAL SPECIFICATION

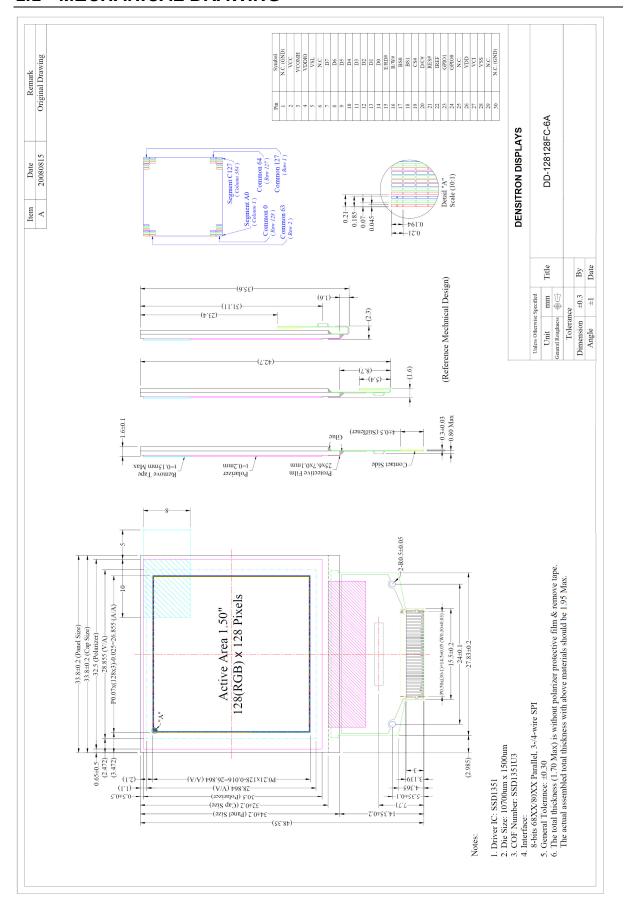
2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	128 (RGB) x 128	Dots
Overall Dimensions	33.8 x 34.00 x 1.60	mm
Viewing Area	28.855 x 28.864	mm
Active Area	26.855 x 26.864	mm
Dot Size	0.045 x RGB x 0.194	mm
Dot Pitch	0.07 x RGB x 0.21	mm
Weight	3.75	g
IC Controller/Driver	SSD1351 (COF)	

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2.2 MECHANICAL DRAWING



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3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Min	Max	Unit	Note
Supply Voltage for Operation	V_{CI}	-0.3	4	V	
Supply Voltage for Logic	V_{DD}	-0.5	2.75	V	
Supply Voltage for I/O Pins	Vddio	-0.5	Vci	V	Note 1, 2
Supply Voltage for Display	Vcc	-0.5	16	V	
Operating Current for Vcc	Icc	-	41.8	mA	
Operating Temperature	Тор	-30	70	°C	
Storage Temperature	Tstg	-40	80	°C	
Static Electricity	Be sure that you are grounded when handling displays.				

Note 1: All the above voltages are on the basis of "VSS=0V".

Note 2: When this module is used beyond above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics" and section 4 "optical characteristic. If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.



3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Operation	V_{CI}	Ta = 25°C	2.4	2.8	3.5	V
Supply Voltage for Logic	V _{DD}	Ta = 25°C	2.4	2.5	2.6	V
Supply Voltage for I/O pins	$V_{ m DDIO}$	Ta = 25°C	1.65	1.8	V_{CI}	V
Supply Voltage for Display	V_{CC}	Note 3	12.5	13	13.5	V
High Level Input	V_{IH}		$0.8 \mathrm{xV}_{\mathrm{DDIO}}$	-	$V_{ m DDIO}$	V
Low Level Input	V_{IL}		0	-	$0.2xV_{\rm DDIO}$	V
High Level Output	V_{OH}	Iout=100µA,3.3MH	$0.9 \mathrm{xV}_{\mathrm{DDIO}}$	-	$V_{ m DDIO}$	V
Low Level Output	$V_{ m OL}$	Iout=100µA,3.3MH	0	-	$0.1 \mathrm{xV}_{\mathrm{DDIO}}$	V
Operating Current for Vci	Icı			240	300	μΑ
	.	Note 1		23.2	29.0	mA
Operating Current for Vcc	Icc	Note 2		33.4	41.8	mA
Sleep Mode Current for VCI	ICI, SLEEP			1	5	μΑ
Sleep Mode Current for Vcc	ICC, SLEEP			1	5	μΑ

Note 1 V_{CI}= 2.8V, V_{CC} = 13V, 50% Display area turned on. Note 2 V_{CI} = 2.8V, V_{CC} = 13V, 100% Display area turned on

Note 3 Brightness (Lbr) and Supply Voltage for Display (Vcc) are subject to the change of the panel characteristics and the customer's request.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function
1	N.C. (GND)	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground.
2	VCC	P	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. It must be connected to external source.
3	VCOMH	P	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and VSS.
4.	VDDIO	Р	Power Supply for I/O Pin This pin is a power supply pin of I/O buffer. It should be connected to VCI or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals) are pulled high, they should be connected to VDDIO.
5	VSL	P	Voltage Output Low Level for SEG Signal This is segment voltage reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, this pin should connect with resistor and diode to ground.
6	N.C.	-	Reserved Pin The N.C. pins between function pins are reserved for compatible and flexible design.
7~14	D7~D0	I/O	Host Data Input/output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. Unused pins must be connected to VSS except for D2.
15	E/RD#	I	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.
16	R/W#	Ι	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.

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No.	Symbol	I/O	Funct	ion	
			Communicating Protocol Select These pins are MCU interface sele table:	ction input. Sec	e the following
17	BS0	τ.		BS0	BS1
18	BS1	I	3-wire SPI	1	0
			4-wire SPI	0	0
			68XX-parallel (8-/16-/18-bit)	1	1
			80XX-parallel (8-/16-/18-bit)	0	1
19	CS#	I	Chip Select This pin is the chip select input. The communication only when CS# is		ed for MCU
20	D/C#	I	Data/Command Control This pin is Data/Command control high, the input at D7~D0 is treated When the pin is pulled low, the input transferred to the command registe relationship to MCU interface sign Timing Characteristics Diagrams. When 3-wire serial mode is selecte connected to VSS	as display data but at D7~D0 w er. For detail als, please refe	n. vill be r to the
21	RES#	Ι	Power Reset for Controller and Driver This pin is reset signal input When the pin is low, initialization of the chip is executed.		v, initialization
22	IREF	I	Current Reference for Brightness A This pin is segment current reference connected between this pin and VS 12.5uA.	ice pin. A resist	
23	GPIO1	7/0	General Purpose Input/Output These pins could be left open indiv		
24	GPIO0	I/O	inputted/outputted. They are able t DC/DC converter circuit enabled/outputcations.		
25	N.C.	-	Reserved Pin The N.C. pins between function pi and flexible design.		for compatible
26	VDD	P	Power Supply for Core Logic Circ This is a voltage supply pin which VCI. A capacitor should be connect under all circumstances.	is regulated int	
27	VCI	P	Power Supply for Operation This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.		
28	VSS	Р	Ground of OEL System This is a ground pin. It also acts as a reference for the logic pins the OEL driving voltages, and the analogue circuits. It must be connected to external ground.		the logic pins,
29	N.C.	-	Reserved Pin The N.C. pins between function pi and flexible design.	ns are reserved	for compatible
30	N.C. (GND)	-	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground.		

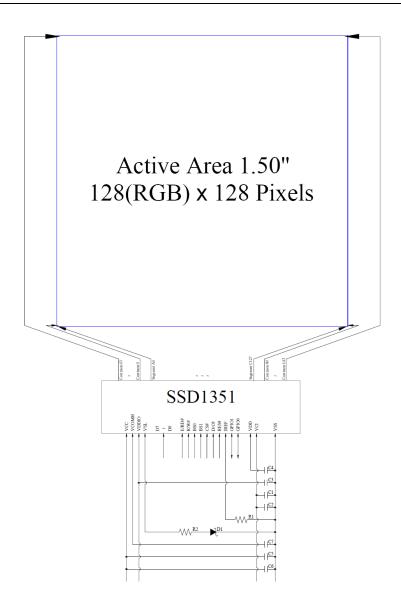
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3.4 BLOCK DIAGRAM



MCU Interface Selection: BS0 and BS1

Pins connected to MCU interface: D7~D0, E/RD#, R/W#, CS#, D/C#, and RES#

 $\begin{array}{ccc} C1, C5: & 0.1 \mu F \\ C2: & 4.7 \mu F \\ C6: & 10 \mu F \\ C3, C4: & 1 \mu F \end{array}$

C7: 4.7uF / 25V Tantalum Capacitor

R1: $560k\Omega$, R1 = (Voltage at IREF – VSS) / IREF

R2: 50Ω , 1/4W D1: <=1.4V, 0.5W

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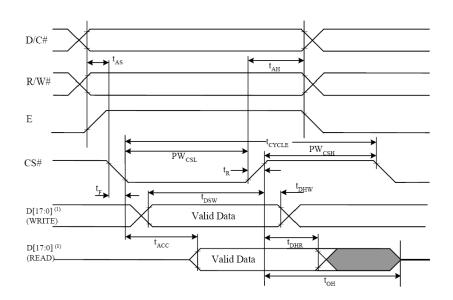
3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

3.5.2 68XX-Series MPU Parallel Interface Timing Characteristics

Characteristics	Symbol	Min	Max	Unit
Clock Cycle Time	$t_{ m cycle}$	300	-	ns
Address Setup Time	t_{AS}	10	-	ns
Address Hold Time	$t_{ m AH}$	0	-	ns
Write Data Setup Time	$t_{ m DSW}$	40	-	ns
Write Data Hold Time	$t_{ m DHW}$	7	-	ns
Read Data Hold Time	$t_{ m DHR}$	20	-	ns
Output Disable Time	t_{OH}	-	70	ns
Access Time	t_{ACC}	-	140	ns
Chip Select Low Pulse Width (Read) Chip Select Low Pulse Width (Write)	PW_{CSL}	120 60	-	ns
Chip Select High Pulse Width (Read) Chip Select High Pulse Width (Write)	PW_{CSH}	60 60	-	ns
Rise Time	t_R	-	15	ns
Fall Time	t_{F}	-	15	ns

 $(V_{DD} - V_{SS} = 2.4V \text{ to } 2.6V, V_{DDIO} = 1.6V, V_{CI} = 2.8V, T_a = 25^{\circ}C)$



When 8-bit Used: D[7:0] Instead

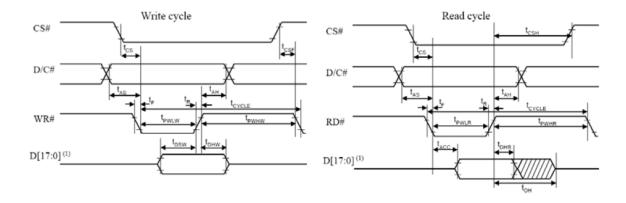
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3.5.3 8080-Series MPU Parallel Interface Timing Characteristics

Characteristics	Symbol	Min	Max	Unit
Clock Cycle Time	$t_{ m cycle}$	300	-	ns
Address Setup Time	t_{AS}	10	-	ns
Address Hold Time	t _{AH}	0	-	ns
Write Data Setup Time	$t_{ m DSW}$	40	-	ns
Write Data Hold Time	$t_{ m DHW}$	7	-	ns
Read Data Hold Time	$t_{ m DHR}$	20	-	ns
Output Disable Time	t_{OH}	-	70	ns
Access Time	t_{ACC}	-	140	ns
Read Low Time	$t_{ m PWLR}$	150	-	ns
Write Low Time	t_{PWLW}	60	-	ns
Read High Time	t_{PWHR}	60	-	ns
Write High Time	t_{PWHW}	60	-	ns
Chip Select Setup Time	t_{CS}	0	-	ns
Chip Select Hold Time to Read Signal	t_{CSH}	0	-	ns
Chip Select Hold Time	t _{CSF}	20	-	ns
Rise Time	t_R	-	15	ns
Fall Time	t_{F}	-	15	ns

 $(V_{DD} - V_{SS} = 2.4V \text{ to } 2.6V, V_{DDIO} = 1.6V, V_{CI} = 2.8V, T_a = 25^{\circ}C)$



* When 8-bit Used: D[7:0] Instead

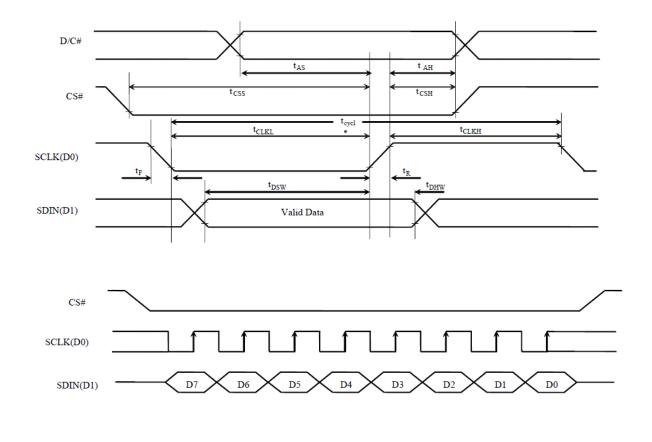
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3.5.4 Serial Interface Timing Characteristics (4-wire SPI)

Characteristics	Symbol	Min	Max	Unit
Clock Cycle Time	$t_{ m cycle}$	50	-	ns
Address Setup Time	t_{AS}	15	-	ns
Address Hold Time	t_{AH}	15	-	ns
Chip Select Setup Time	t_{CSS}	20	-	ns
Chip Select Hold Time	t_{CSH}	10	-	ns
Write Data Setup Time	$t_{ m DSW}$	15	-	ns
Write Data Hold Time	$t_{ m DHW}$	15	-	ns
Clock Low Time	t_{CLKL}	20	-	ns
Clock High Time	t_{CLKH}	20		ns
Rise Time	t_R	-	15	ns
Fall Time	$t_{ m F}$	-	15	ns

 $(VDD - VSS = 2.4V \text{ to } 2.6V, VDDIO = 1.6V, VCI = 2.8V, Ta = 25^{\circ}C)$



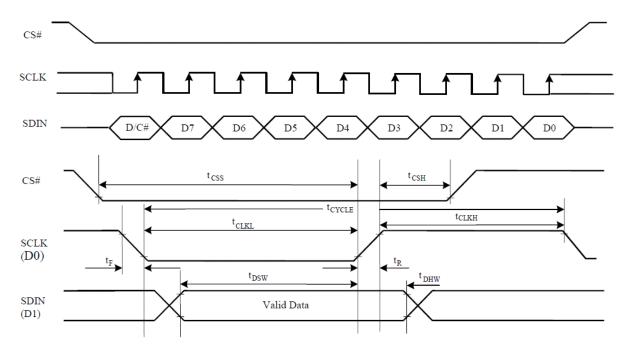
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3.5.5 Serial Interface Timing Characteristics (3-wire SPI)

Characteristics	Symbol	Min	Max	Unit
Clock Cycle Time	$t_{ m cycle}$	50	-	ns
Chip Select Setup Time	$t_{\rm CSS}$	20	1	ns
Chip Select Hold Time	t_{CSH}	10	-	ns
Write Data Setup Time	$t_{ m DSW}$	15	-	ns
Write Data Hold Time	$t_{ m DHW}$	15	-	ns
Clock Low Time	t_{CLKL}	20	-	ns
Clock High Time	t_{CLKH}	20		ns
Rise Time	t_{R}	-	15	ns
Fall Time	t_{F}	-	15	ns

 $(VDD - VSS = 2.4V \text{ to } 2.6V, VDDIO = 1.6V, VCI = 2.8V, Ta = 25^{\circ}C)$



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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness(White)	L_{br}	With Polarizer (Note 3)	70	90	-	cd/m ²
C.I.E.(White)	(X)	With Polarizer	0.26	0.30	0.34	
C.I.E.(Willie)	(Y)	with Foldinger	0.29	0.33	0.37	-
CIE (Pad)	(X)	With Polarizer	0.60	0.64	0.68	
C.I.E.(Red)	(Y)	with Folarizer	0.30	0.34	0.38	_
CIE (Graan)	(X)	With Polarizer	0.27	0.31	0.35	
C.I.E.(Green)	(Y)	with Foldlizer	0.58	0.62	0.66	_
C LE (Dlue)	(X)	With Polarizer	0.10	0.14	0.18	
C.I.E.(Blue)	(Y)	with Polarizer	0.12	0.16	0.20	-
Dark Room Contrast	CR		-	>2000:1	-	-
Viewing Angle			>160	-	-	degree

Optical measurement taken at V_{CI} = 2.8V, V_{CC} = 13V Software configuration follows Section 5.4 Initialization.

Note 3 Brightness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customer's request.

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

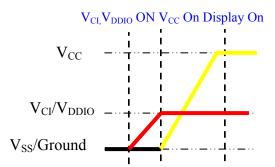
Please refer to the Technical Manual for the SSD1351

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

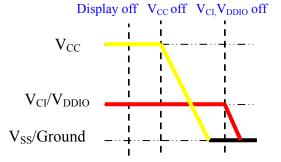
5.2.1 POWER UP SEQUENCE

- 1. Power up V_{CI} & V_{DDIO}
- 2. Send Display off command
- 3. Initialization 4. Clear Screen
- 5. Power up V_{CC}
- 6. Delay 100ms (When V_{CC} is stable)
- 7. Send Display on command



5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{CC}
- 3. Delay 100ms (When V_{CC} is reach 0 and panel is completely discharges)
- 4. Power down V_{CI &} V_{DDIO}



5.3 RESET CIRCUIT

When RES# input is low, the chip is initialized with the following status:

- 1. Display is off
- 2. 128(RGB)x128 Display Mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Display start line is set at display RAM address 0
- 5. Column address counter is set at 0
- 6. Normal scan direction of the COM outputs
- 7. Command A2h, B1h, B3h, BBh, BEh are locked by command FDh

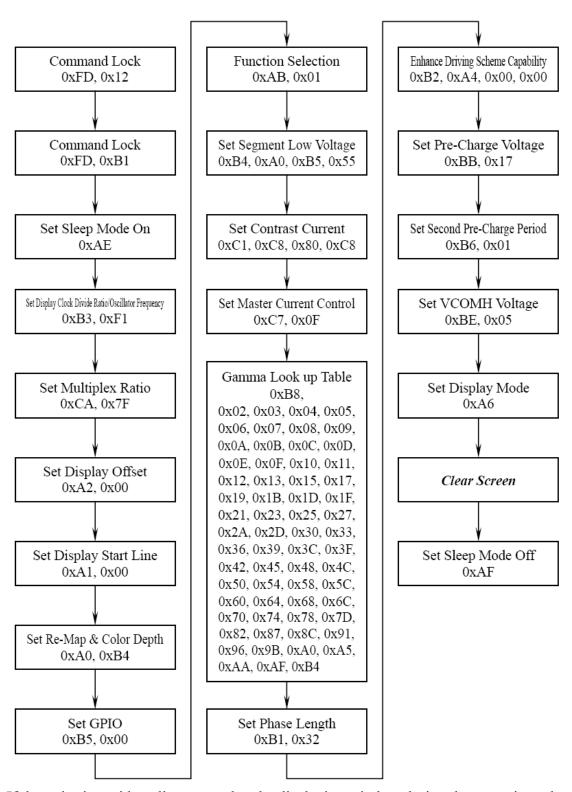
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5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example



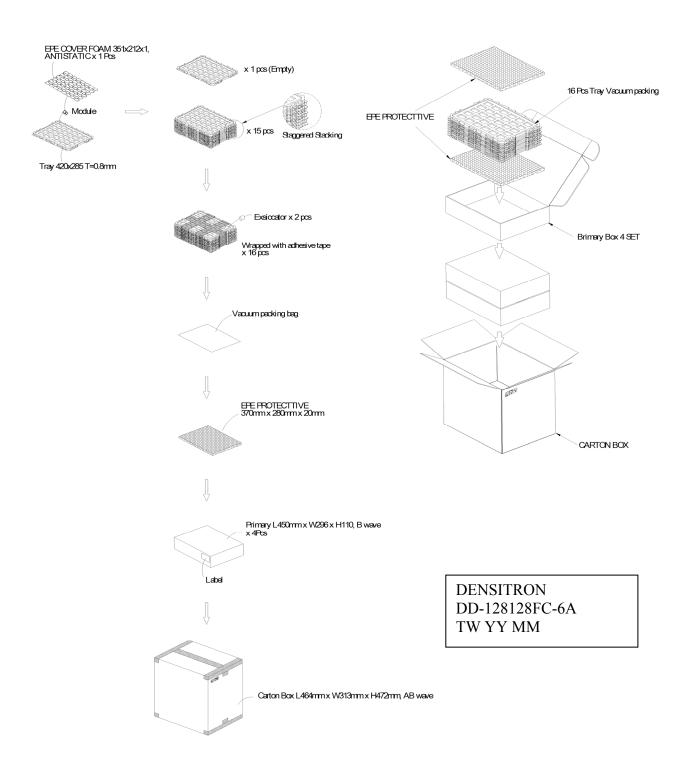
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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6 PACKAGING AND LABELLING SPECIFICATION

6.1 LABELLING & MARKING



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

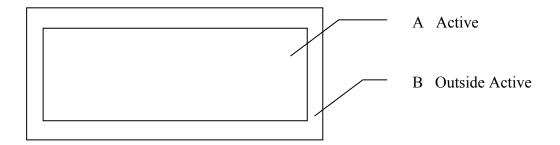
The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions

Temperature: 23 ± 5 °C

Humidity: 55 ± 15 %RH

Fluorescent lamp: 30 WDistance between the Panel & Eyes of the Inspector: $\geq 30 \text{cm}$ Distance between the Panel & the lamp: $\geq 50 \text{cm}$

7.2.4 Standard of appearance inspection

Units: mm

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Class	Item		Criteria	1	
Minor	Packing &	Outside & inside package	Presence of pro	oduct no., lot no.,	quantity
Critical	Label	Product must not be mixe			<u> </u>
011110		that indicated on the label		quarity must net	
Major	Dimension	Product dimensions must		pecification and di	rawing
3			0 1		C
Major	Electrical	Product electrical charact	eristics must be ac	cording to specifi	cation
Critical	OLED Display	Missing lines, short circu allowed	its or wrong patter	ns on OLED disp	lay are not
Minor	Black spot, white spot,	Round type: as per follow $\emptyset = (X+Y)/2$	ving drawing		
	dust	(A+1)/2	Α	cceptable quantity	I
			Size	Zone A	Zone B
			Ø<0.1	Any number	2016 2
		Y	0.1<Ø<0.2	3	
		A	0.2<Ø<0.25	1	Any number
		X	0.25<Ø	0	
		Line type: as per following		ole quantity	
		W Length	Width	Zone A	Zone B
			W≤0.05	Any number	
		/	W≤0.1	3	Any number
		L>2.0		0	
		•	table quantity: 3		
Minor	Polariser	Scratch on protective film	•		
Minor	scratch	Scratch on polariser: same	e as No. I		
IVIIIOF	Polariser bubble	$\emptyset = (X+Y)/2$	Α.	agantahla ayantit	,
	ouddic.	Acceptable quantity Size Zone A Zone B			
		_	\varnothing <0.5	Any number	
		V	Ø>0.5	0	Any number
		X	0.0	•	1

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Class	Item	Criteri	a	
Minor	Segment deformation	1b. Pin hole on dot matrix display	Acceptable Size $a,b<0.1$ $(a+b)/2\leq0.1$ $0.5<\varnothing<1.0$ Total acceptable	Any number Any number 3
		2. Segments / dots with different width	Accep <u>a≥b</u> a <b< td=""><td>table a/b≤4/3 a/b>4/3</td></b<>	table a/b≤4/3 a/b>4/3
		3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size $\emptyset \le 0.4$ $0.4 < \emptyset \le 1.0$ $1.0 < \emptyset \le 1.5$ $1.5 < \emptyset \le 2.0$ Total acceptable	Any number 5 3 2
Minor	Panel Chipping	$X \le 1/6$ Panel length $Y \le 1$ $Z \le T$		Z
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item		Crit	teria	
Minor	Contact Lead Twist	Not allowed		D. TVISTED LEAD	
Minor	Contact Lead Broken	Not allowed A. BROKEN LEAD			
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit			
		Not allowed if bent extends horizontall more than 50% of its width			
Minor	Colour uniformity	Level of sample for approval set as limit sample			
Major	PCB _	No unmelted solder paste should be present on PCB			
Critical		Cold solder joints, missing solder connections, or oxidation are not allowed			
Minor		No residue or solder balls on PCB are allowed			
Critical		Short circuits on components are not allowed			
Minor	Tray particles			Size Ø<0.2	Quantity Any number
	particles		On tray	Ø<0.2 Ø>0.25	Any number 4
			0 1: 1	Ø≥0.25	2
			On display	L = 3	1

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment	
High Temperature Operation	70°C±2, 240 hours	No abnormalities in function and appearance	
Low Temperature Operation	-30°C±2, 240 hours	No abnormalities in function and appearance	
High Temperature Storage	80°C±2, 240 hours	No abnormalities in function and appearance	
Low Temperature Storage	-40°C±2, 240 hours	No abnormalities in function and appearance	
High Temperature & High Humidity Storage(Operation)	60°C±2, 90%RH, 120 hours	No abnormalities in function and appearance	
Thermal Shock	24 cycle of -40°C 1 Hour, R.T. 5 min, 85°C 1 Hour	No abnormalities in function and appearance	

- The samples used for above tests do not include polarizer.
- No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23±5 °C 55±15% RH

8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 10,000 hours under ordinary operating conditions of room temperature (25±10 °C), normal humidity (45±20% RH), and in area not exposed to direct sunlight. Storage Life time is 20,000 hr under room temperature (25±10 °C), normal humidity (45±20% RH)
2	End of lifetime is specified as 50% of initial brightness.

8.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.

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9 PRECAUTIONS

9.1 Handling

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$ and the humidity below 50%RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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9.2 STORAGE

When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Factory.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

9.3 DESIGNING

The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.

To prevent occurrence of malfunctioning by noise: pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.

We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VCI). (Recommend value: 0.5A)

Pay sufficient attention to avoid occurrence of mutual noise interference with the neighbouring devices.

As for EMI, take necessary measures on the equipment side basically.

When fastening the OEL display module, fasten the external plastic housing section.

If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.

The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1351 * Connection (contact) to any other potential than the above may lead to rupture of the IC.

9.4 Disposing

Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

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9.5 Other

When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.

- * Pins and electrodes
- * Pattern layouts such as the COF

With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.

- * Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.

Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

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